



BSS84

P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	I _D T _A = 25°C		
-50V	10Ω @ V _{GS} = -5V	-130mA		

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

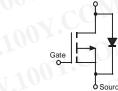
- General Purpose Interfacing Switch
- **Power Management Functions**
- Analog Switch

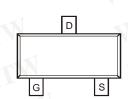
Mechanical Data

- Case: SOT-23
- Case Material: UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish).
- Terminal Connections: See Diagram
- Weight: 0.008 grams (approximate)

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Top View

Top View

Equivalent Circuit

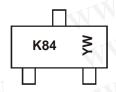
Ordering Information (Note 3)

Part Number	Case	Packaging
BSS84-7-F	SOT-23	3000/Tape & Reel
BSS84Q-7-F	SOT-23	3000/Tape & Reel
BSS84-13-F	SOT-23	10000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free
- 2. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants 3. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf

Marking Information



K84 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002)M = Month (ex: 9 = September)

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L.	M	N	Р	R	S	ŢU	U	V	W	Х	Υ	Z
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1011	2	A.T.	3	4	5	6		7	8	9	0	P -	N	D



Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units		
Drain-Source Voltage		V _{DSS}	-50	V		
Drain-Gate Voltage $R_{GS} \le 20$ KΩ		V_{DGR}	-50	V		
Gate-Source Voltage	Continuous	V _{GSS}	±20	V		
Drain Current (Note 4)	Continuous	I _D	-130	mA		
Pulsed Drain Current		I _{DM}	-1.2	A		

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	P _D	300	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)		Mr.		_			
Drain-Source Breakdown Voltage	BV _{DSS}	-50	ĺ	F	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		 	-15 -60 -100	μA μA nA	$V_{DS} = -50V$, $V_{GS} = 0V$, $T_{J} = 25^{\circ}C$ $V_{DS} = -50V$, $V_{GS} = 0V$, $T_{J} = 125^{\circ}C$ $V_{DS} = -25V$, $V_{GS} = 0V$, $T_{J} = 25^{\circ}C$	
Gate-Body Leakage	I _{GSS}		(-)	±10	nΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)	-1	Dr.		-41	1	-310	
Gate Threshold Voltage	V _{GS(th)}	-0.8	_	-2.0	V	$V_{DS} = V_{GS}$, $I_D = -1mA$	
Static Drain-Source On-Resistance	R _{DS (ON)}	1	TT.	10	Ω	$V_{GS} = -5V, I_D = -0.100A$	
Forward Transconductance	g _{FS}	0.05	_		S	$V_{DS} = -25V, I_{D} = -0.1A$	
DYNAMIC CHARACTERISTICS (Note 6)	-1 1.11U -	_	-1				
Input Capacitance	C _{iss}			45	рF		
Output Capacitance	Coss			25	pF	$V_{DS} = -25V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Reverse Transfer Capacitance	C _{rss}	_	an'	12	pF		
SWITCHING CHARACTERISTICS (Note 6)		47 (2			
Turn-On Delay Time	t _{D(ON)}	7	10	-	ns	$V_{DD} = -30V, I_D = -0.27A,$	
Turn-Off Delay Time	t _{D(OFF)}		18	177.	ns	$R_{GEN} = 50\Omega$, $V_{GS} = -10V$	

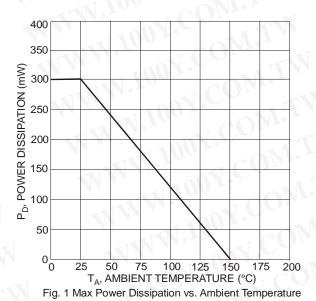
Notes:

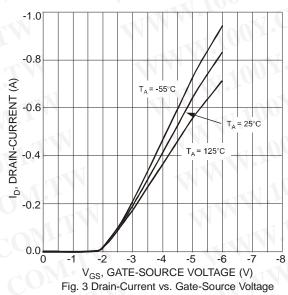
- 4. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. Short duration pulse test used to minimize self-heating effect. Guaranteed by design. Not subject to production testing

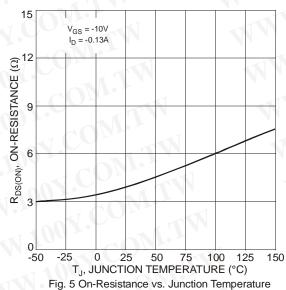
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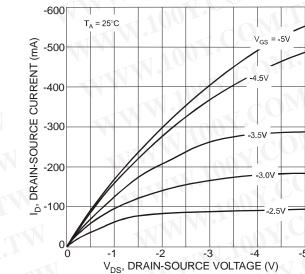


Fig. 2 Drain-Source Current vs. Drain-Source Voltage

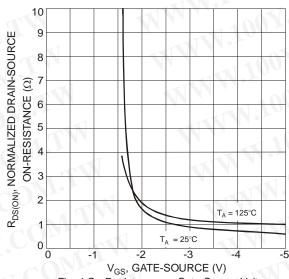


Fig. 4 On-Resistance vs. Gate-Source Voltage

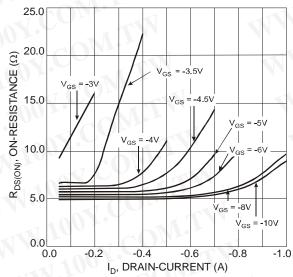
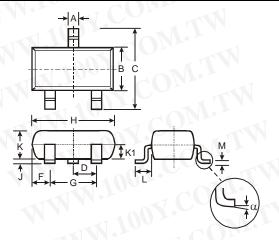


Fig. 6 On-Resistance vs. Drain-Current

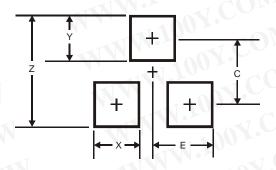


Package Outline Dimensions



4	SOT-23									
Dim	Min	Max	Тур							
Α	0.37	0.51	0.40							
В	1.20	1.40	1.30							
С	2.30	2.50	2.40							
D	0.89	1.03	0.915							
F	0.45	0.60	0.535							
G	1.78	2.05	1.83							
Н	2.80	3.00	2.90							
J	0.013	0.10	0.05							
K	0.903	1.10	1.00							
K1 1		1	0.400							
L	0.45	0.61	0.55							
M	0.085	0.18	0.11							
α	0°	8°	-							
All	All Dimensions in mm									

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
С	2.0
E	1.35

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